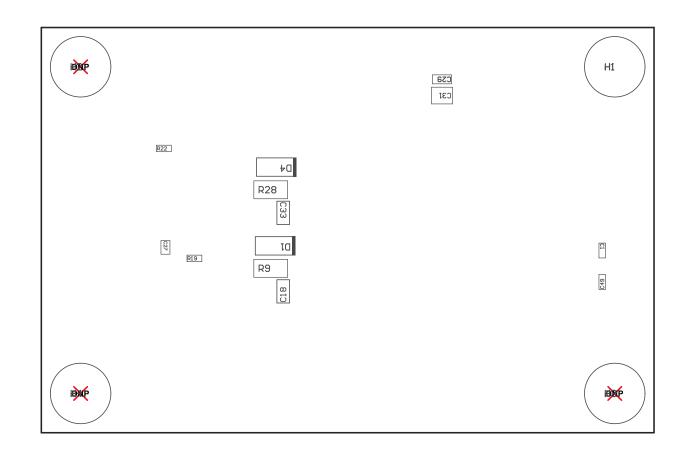


## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE         | BOARD #: PMP15032  | REV: A       | SUN REU: | Not In VersionControl |  |  |
|----------------------------------|--------------------|--------------|----------|-----------------------|--|--|
|                                  | TID #: PMP15032    |              |          |                       |  |  |
| PLOT NAME = Top Assembly Drawing | GENERATED : 6/16/2 | 2017 1:55:17 | PM       | TEXAS INSTRUMENTS     |  |  |



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: PMP15032  | REV: A      | SUN REV: | Not In VersionControl |  |
|-------------------------------------|--------------------|-------------|----------|-----------------------|--|
|                                     | TID #: PMP15032    |             |          |                       |  |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 6/16/2 | 017 1:55:18 | PM       | TEXAS INSTRUMENTS     |  |

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